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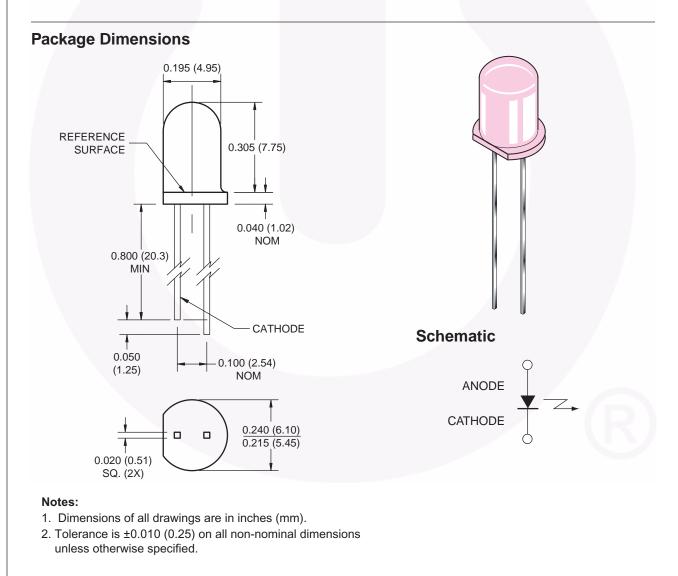
## QED121, QED122, QED123 Plastic Infrared Light Emitting Diode

### Features

- λ = 880nm
- Chip material = AlGaAs
- Package type: T-1 3/4 (5mm lens diameter)
- Matched photosensor: QSD122/QSD123/QSD124
- Narrow emission angle, 16°
- High output power
- Package material and color: clear, peach tinted, plastic

### Description

The QED121, QED122 and QED123 are 880nm AlGaAs LEDs encapsulated in a clear peach tinted, plastic T-1 3/4 package.



# QED121, QED122, QED123 — Plastic Infrared Light Emitting Diode

August 2008

### Absolute Maximum Ratings (T<sub>A</sub> = 25°C unless otherwise specified)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

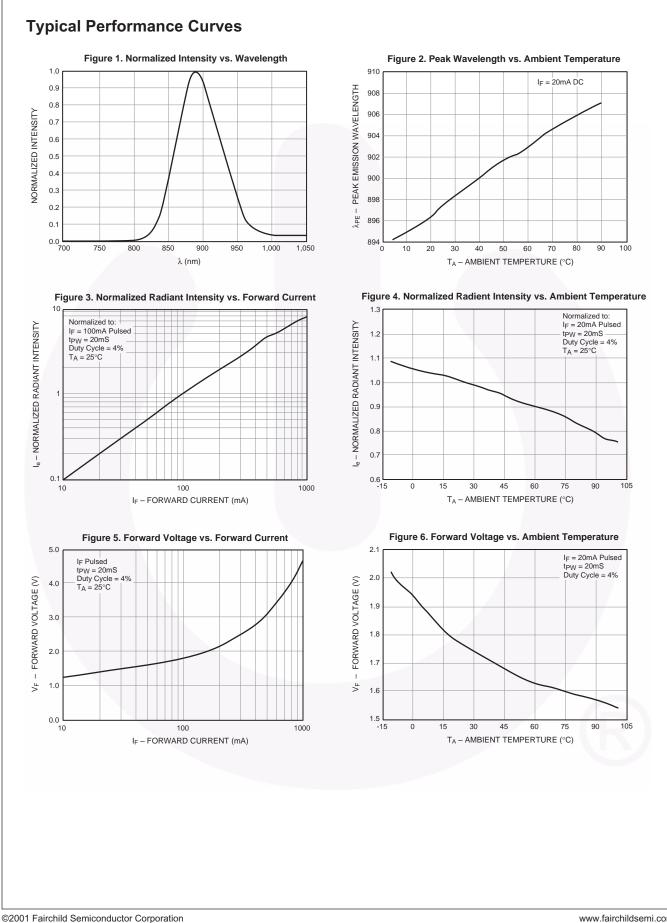
Symbol	Parameter	Rating	Units
T <sub>OPR</sub>	Operating Temperature	-40 to +100	°C
T <sub>STG</sub>	Storage Temperature	-40 to +100	°C
T <sub>SOL-I</sub>	Soldering Temperature (Iron) <sup>(2)(3)(4)</sup>	240 for 5 sec	°C
T <sub>SOL-F</sub>	Soldering Temperature (Flow) <sup>(2)(3)</sup>	260 for 10 sec	°C
١ <sub>F</sub>	Continuous Forward Current	100	mA
V <sub>R</sub>	Reverse Voltage	5	V
PD	Power Dissipation <sup>(1)</sup>	200	mW

### Notes:

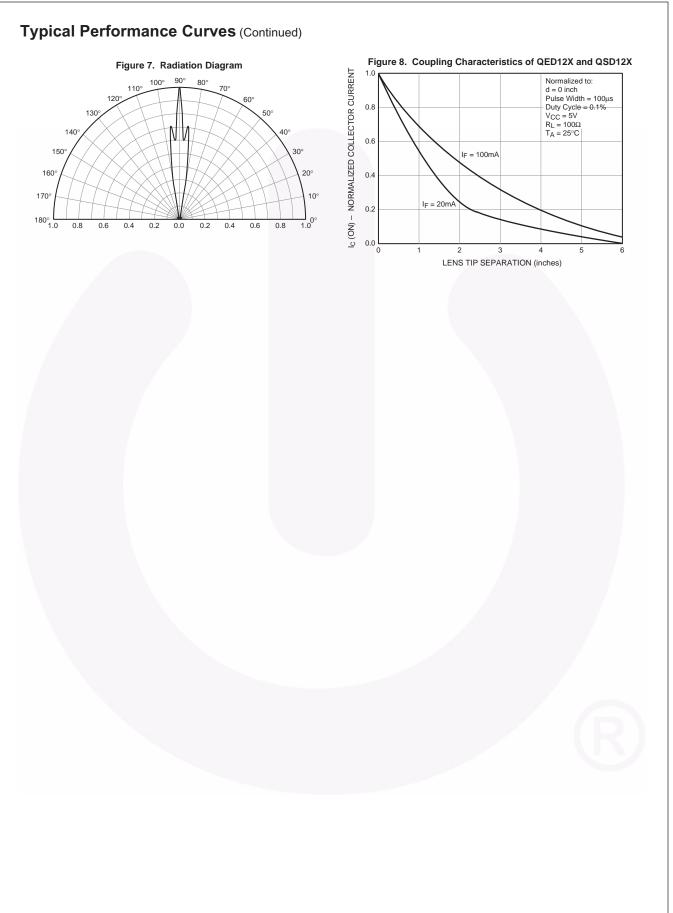
- 1. Derate power dissipation linearly 2.67mW/°C above 25°C.
- 2. RMA flux is recommended.
- 3. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 4. Soldering iron 1/16" (1.6mm) minimum from housing.

### **Electrical / Optical Characteristics** (T<sub>A</sub> = 25°C)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
$\lambda_{PE}$	Peak Emission Wavelength	I <sub>F</sub> = 20mA		890		nm
$TC_{\lambda}$	Temperature Coefficient			0.2		nm/°C
2\[Gamma]/2	Emission Angle	I <sub>F</sub> = 100mA		16		0
V <sub>F</sub>	Forward Voltage	$I_{\rm F} = 100 {\rm mA}, {\rm tp} = 20 {\rm ms}$			1.7	V
TC <sub>VF</sub>	Temperature Coefficient			-6		mV/°C
I <sub>R</sub>	Reverse Current	$V_R = 5V$			10	μA
Ι <sub>Ε</sub>	Radiant Intensity QED121	$I_{\rm F}$ = 100mA, tp = 20ms	16		40	mW/sr
١ <sub>E</sub>	Radiant Intensity QED122	$I_{\rm F}$ = 100mA, tp = 20ms	32		100	mW/sr
١ <sub>E</sub>	Radiant Intensity QED123	$I_{\rm F}$ = 100mA, tp = 20ms	50	70		mW/sr
TCIE	Temperature Coefficient			-0.3		%/°C
t <sub>r</sub>	Rise Time	I <sub>F</sub> = 100mA		900		ns
t <sub>f</sub>	Fall Time			800		ns
Cj	Junction Capacitance	$V_R = 0V$		11		pF



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